

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yiu Fai KWAN</td> <td>02/09/2007</td> </tr> <tr> <td>Tat Chi CHAN</td> <td>02/09/2007</td> </tr> <tr> <td>Wai CHAN</td> <td>03/01/2007</td> </tr> <tr> <td>Chi Chung LEE</td> <td>02/09/2007</td> </tr> </tbody> </table>		Name	Execution Date	Yiu Fai KWAN	02/09/2007	Tat Chi CHAN	02/09/2007	Wai CHAN	03/01/2007	Chi Chung LEE	02/09/2007
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Yiu Fai KWAN	02/09/2007										
Tat Chi CHAN	02/09/2007										
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Chi Chung LEE	02/09/2007										
RECEIVING PARTY DATA											
Name:	ASM Assembly Materials Ltd										
Street Address:	20/F., Watson Centre, 16-22 Kung Yip St.,										
Internal Address:	Kwai Chung										
City:	Hong Kong										
State/Country:	HONG KONG										
PROPERTY NUMBERS Total: 1											
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11683234</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11683234						
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Application Number:	11683234										
CORRESPONDENCE DATA											
Fax Number:	(212)382-0888										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
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Email:	sgoodenough@ostrolenk.com										
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Address Line 1:	1180 Avenue Of The Americas										
Address Line 4:	New York, NEW YORK 10036										
ATTORNEY DOCKET NUMBER:	P/4076-149 V3074										
NAME OF SUBMITTER:	Robert C. Faber										
Total Attachments: 1 source=00824034#page1.tif											

OP \$40.00 11683234

PATENT

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REEL: 018976 FRAME: 0496

PATENT APPLICATION ASSIGNMENT -
SOLE AND JOINT INVENTORS
EXECUTED OUTSIDE USA


OFCS FILE NO. P/4076-149

WHEREAS, I (We), Yiu Fai KWAN, Tat Chi CHAN, Wai CHAN and Chi Chung LEE as assignor(s), have invented certain improvements in LEADFRAME TREATMENT FOR ENHANCING ADHESION OF ENCAPSULANT THERETO for which an application for United States Letters Patent has been executed by me of even date herewith; and

WHEREAS, ASM Assembly Materials Ltd, a corporation organized and existing under the laws of Hong Kong, China SAR and having a principal place of business at 20/F., Watson Centre, 16-22 Kung Yip St., Kwai Chung, Hong Kong, China SAR as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.


NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I (We), as assignor(s), hereby sell, assign and set over to said assignee the entire right, title and interest for the United States and all other countries in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute or reissue applications and patents applied for or granted therefor in the United States and all other countries, including all rights of priority from the filing of said application, and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for myself (ourselves) and my (our) legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States and all other countries, the expenses incident to said applications to be borne and paid by said assignee.

Date: 2/9/07



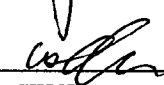
Yiu Fai KWAN

Date: 2/9/07



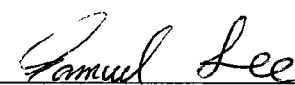
Tat Chi CHAN

Date: 3/1/07



Wai CHAN

Date: 2/9/07



Chi Chung LEE